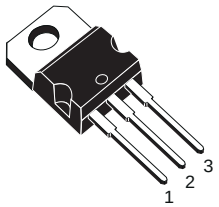
# IRF530

## N-CHANNEL 100V - 0.115 Ω - 14A TO-220
## LOW GATE CHARGE STripFET™ II POWER MOSFET

| TYPE | $V_{DSS}$ | $R_{DS(on)}$ | $I_D$ |
|---|---|---|---|
| IRF530 | 100 V | <0.16 Ω | 14 A |

- TYPICAL $R_{DS}(on)$ = 0.115Ω
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- 175 °C OPERATING TEMPERATURE




**TO-220**

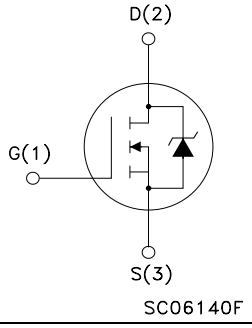
### DESCRIPTION

This MOSFET series realized with STMicroelectronics unique STripFET™ process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced high-efficiency, high-frequency isolated DC-DC converters for Telecom and Computer applications. It is also intended for any applications with low gate drive requirements.

### APPLICATIONS

- HIGH CURRENT, HIGH SWITCHING SPEED
- SOLENOID AND RELAY DRIVERS
- REGULATOR
- DC-DC & DC-AC CONVERTERS
- MOTOR CONTROL, AUDIO AMPLIFIERS
- AUTOMOTIVE ENVIRONMENT (INJECTION, ABS, AIR-BAG, LAMPDRIVERS, etc.)

### INTERNAL SCHEMATIC DIAGRAM




### ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|---|---|---|---|
| $V_{DS}$ | Drain-source Voltage ($V_{GS}$ = 0) | 100 | V |
| $V_{DGR}$ | Drain-gate Voltage ($R_{GS}$ = 20 kΩ) | 100 | V |
| $V_{GS}$ | Gate- source Voltage | ± 20 | V |
| $I_D$ | Drain Current (continuous) at $T_C$ = 25°C | 14 | A |
| $I_D$ | Drain Current (continuous) at $T_C$ = 100°C | 10 | A |
| $I_{DM}$(•) | Drain Current (pulsed) | 56 | A |
| $P_{tot}$ | Total Dissipation at $T_C$ = 25°C | 60 | W |
| | Derating Factor | 0.4 | W/°C |
| dv/dt (1) | Peak Diode Recovery voltage slope | 20 | V/ns |
| $E_{AS}$ (2) | Single Pulse Avalanche Energy | 70 | mJ |
| $T_{stg}$ | Storage Temperature | -55 to 175 | °C |
| $T_j$ | Operating Junction Temperature | | |

(•) Pulse width limited by safe operating area.

(1) $I_{SD}$ ≤14A, di/dt ≤300A/µs, $V_{DD}$ ≤ $V_{(BR)DSS}$, $T_j$ ≤ $T_{JMAX}$
(2) Starting $T_j$ = 25 °C, $I_D$ = 14A, $V_{DD}$ = 50V



NEW DATASHEET ACCORDING TO PCN DSG/CT/1C02 MARKING: IRF530 @.

## THERMAL DATA

| | | | | |
|---|---|---|---|---|
| Rthj-case | Thermal Resistance Junction-case | Max | 2.5 | °C/W |
| Rthj-amb | Thermal Resistance Junction-ambient | Max | 62.5 | °C/W |
| $T_l$ | Maximum Lead Temperature For Soldering Purpose | | 300 | °C |

## ELECTRICAL CHARACTERISTICS ($T_{case}$ = 25 °C unless otherwise specified)

OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| $V_{(BR)DSS}$ | Drain-source Breakdown Voltage | $I_D$ = 250 µA, $V_{GS}$ = 0 | 100 | | | V |
| $I_{DSS}$ | Zero Gate Voltage Drain Current ($V_{GS}$ = 0)<br>Zero Gate Voltage Drain Current ($V_{GS}$ = 0) | $V_{DS}$ = Max Rating<br>$V_{DS}$ = Max Rating $T_C$ = 100°C | | | 1<br>10 | µA<br>µA |
| $I_{GSS}$ | Gate-body Leakage Current ($V_{DS}$ = 0) | $V_{GS}$ = ± 20 V | | | ±100 | nA |

ON (*)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}$ = $V_{GS}$ $I_D$ = 250 µA | 2 | 3 | 4 | V |
| $R_{DS(on)}$ | Static Drain-source On Resistance | $V_{GS}$ = 10 V $I_D$ = 7 A | | 0.115 | 0.16 | Ω |

DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| $g_{fs}$ (*) | Forward Transconductance | $V_{DS}$ = 15 V $I_D$ = 7 A | | 7 | | S |
| $C_{iss}$<br>$C_{oss}$<br>$C_{rss}$ | Input Capacitance<br>Output Capacitance<br>Reverse Transfer Capacitance | $V_{DS}$ = 25V, f = 1 MHz, $V_{GS}$ = 0 | | 458<br>68<br>29 | | pF<br>pF<br>pF |

**ELECTRICAL CHARACTERISTICS** (continued)

SWITCHING ON

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| $t_{d(on)}$<br>$t_r$ | Turn-on Delay Time<br>Rise Time | $V_{DD}$ = 50 V $I_D$ = 7 A<br>$R_G$ = 4.7 Ω $V_{GS}$ = 10 V<br>(Resistive Load, Figure 3) | | 16<br>25 | | ns<br>ns |
| $Q_g$<br>$Q_{gs}$<br>$Q_{gd}$ | Total Gate Charge<br>Gate-Source Charge<br>Gate-Drain Charge | $V_{DD}$ = 80V $I_D$ = 14A $V_{GS}$= 10V | | 16<br>3.7<br>4.7 | 21 | nC<br>nC<br>nC |

SWITCHING OFF

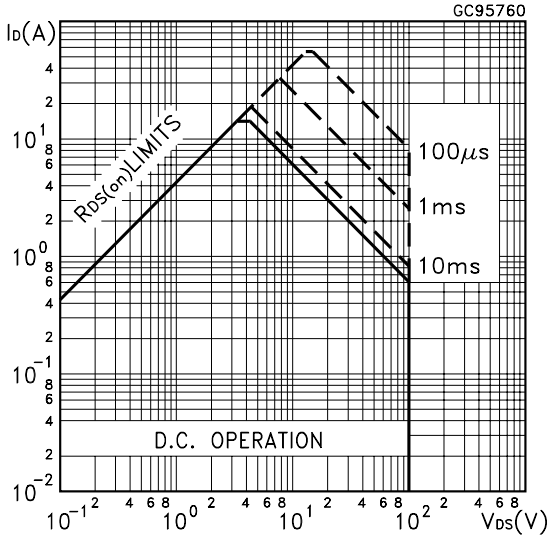
| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| $t_{d(off)}$<br>$t_f$ | Turn-off Delay Time<br>Fall Time | $V_{DD}$ = 50 V $I_D$ = 7 A<br>$R_G$ = 4.7Ω, $V_{GS}$ = 10 V<br>(Resistive Load, Figure 3) | | 32<br>8 | | ns<br>ns |

SOURCE DRAIN DIODE

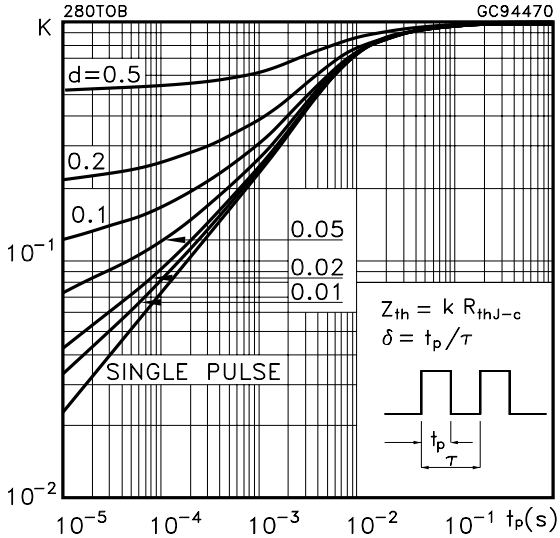
| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| $I_{SD}$<br>$I_{SDM}$ (•) | Source-drain Current<br>Source-drain Current (pulsed) | | | | 14<br>56 | A<br>A |
| $V_{SD}$ (*) | Forward On Voltage | $I_{SD}$ = 14 A $V_{GS}$ = 0 | | | 1.6 | V |
| $t_{rr}$<br>$Q_{rr}$<br>$I_{RRM}$ | Reverse Recovery Time<br>Reverse Recovery Charge<br>Reverse Recovery Current | $I_{SD}$ = 14 A di/dt = 100A/µs<br>$V_{DD}$ = 10V $T_j$ = 150°C<br>(see test circuit, Figure 5) | | 92<br>230<br>5 | | ns<br>nC<br>A |

(*)Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %.
(•)Pulse width limited by safe operating area.

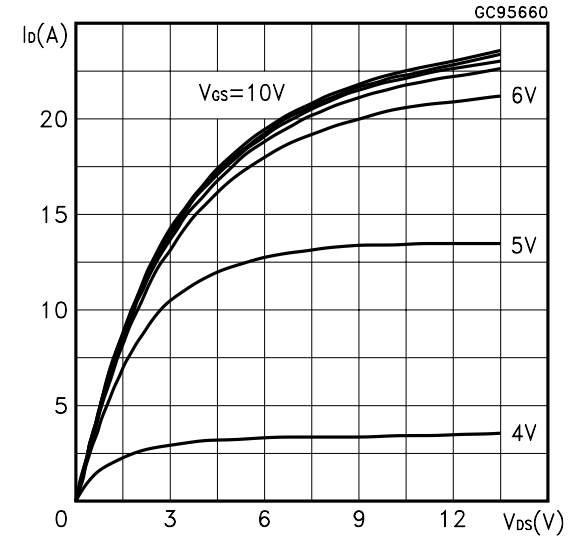
Safe Operating Area



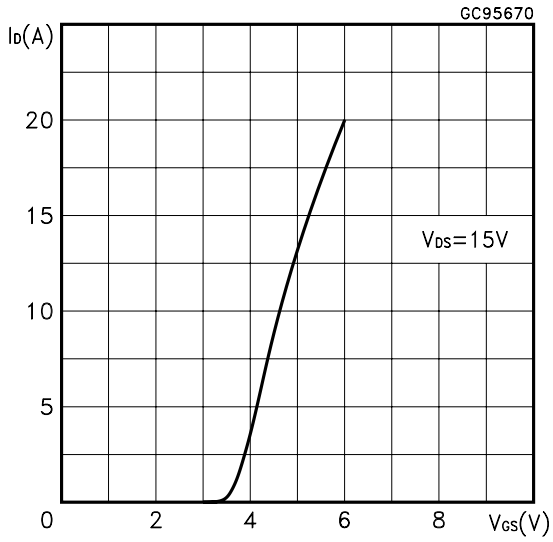

Thermal Impedance



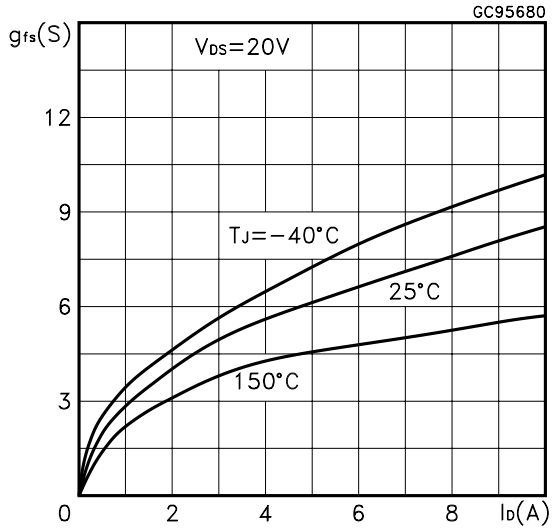
Output Characteristics



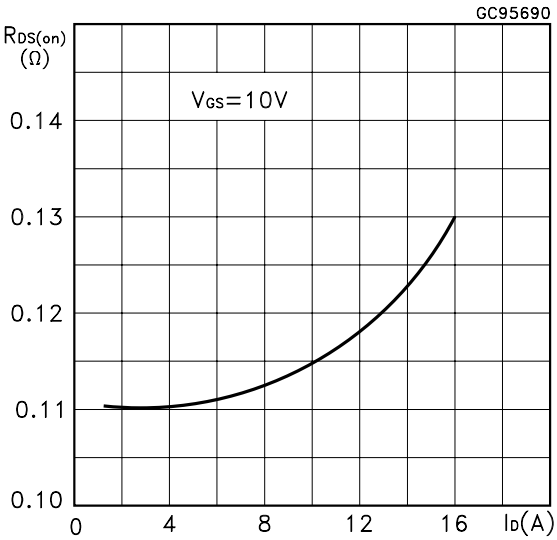

Transfer Characteristics



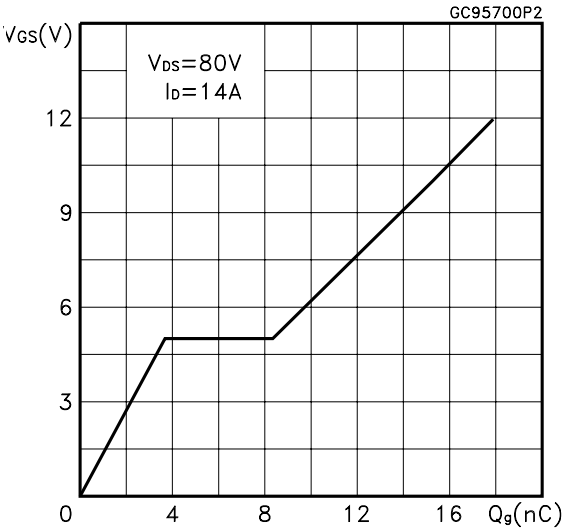

Transconductance



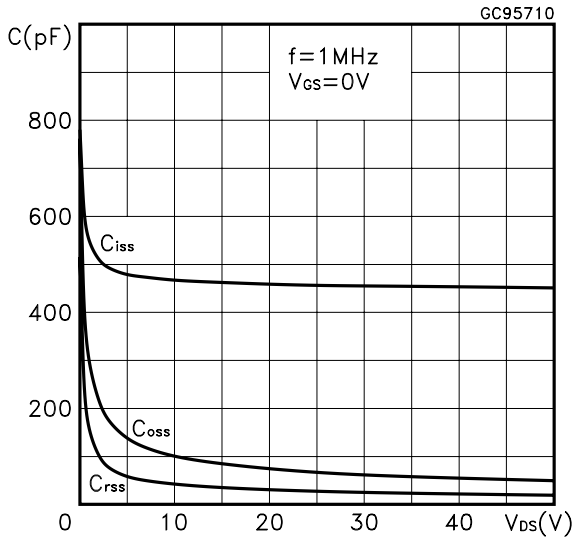

Static Drain-source On Resistance



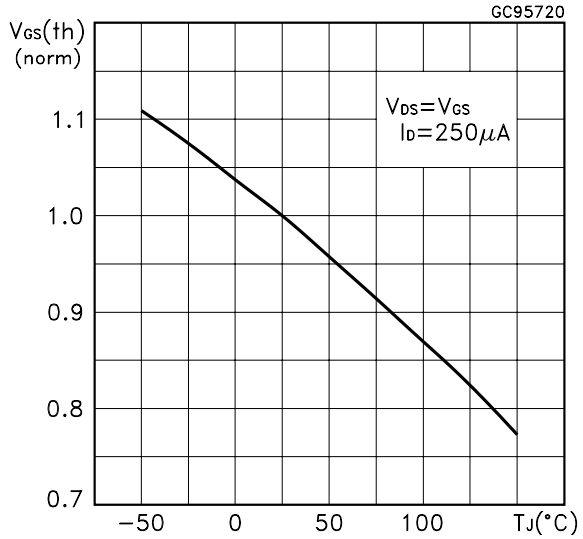

Gate Charge vs Gate-source Voltage



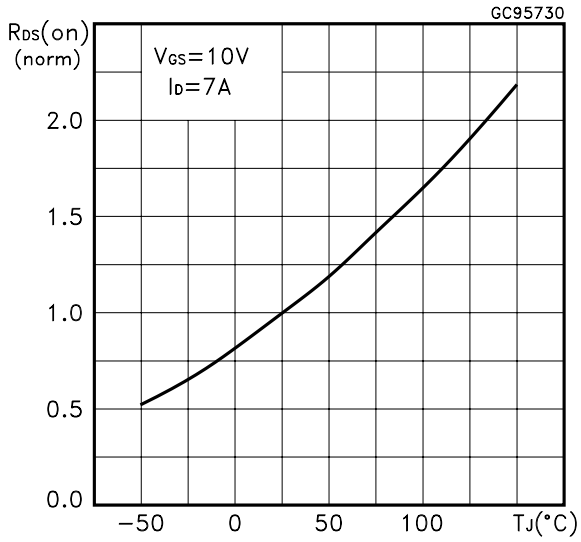

Capacitance Variations



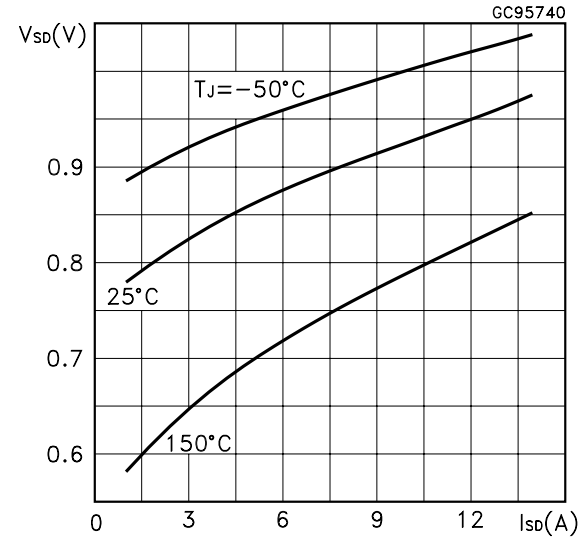
Normalized Gate Threshold Voltage vs Temperature




Normalized on Resistance vs Temperature




Source-drain Diode Forward Characteristics




Normalized Breakdown Voltage vs Temperature

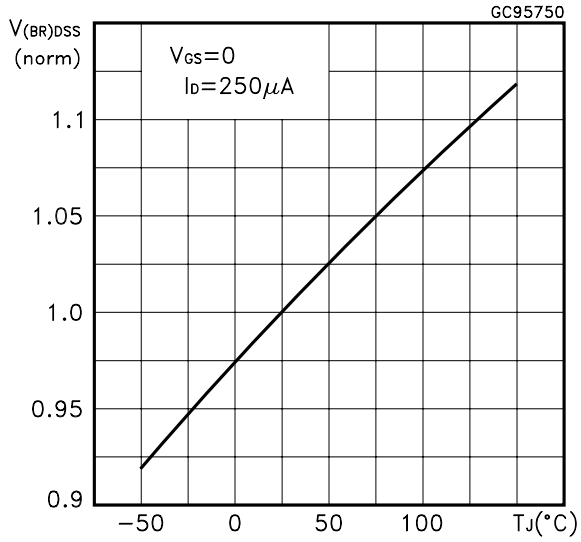


**Fig. 1:** Unclamped Inductive Load Test Circuit

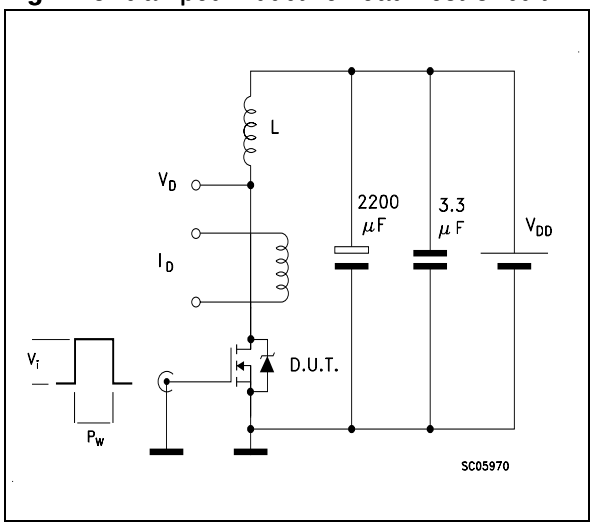



**Fig. 2:** Unclamped Inductive Waveform

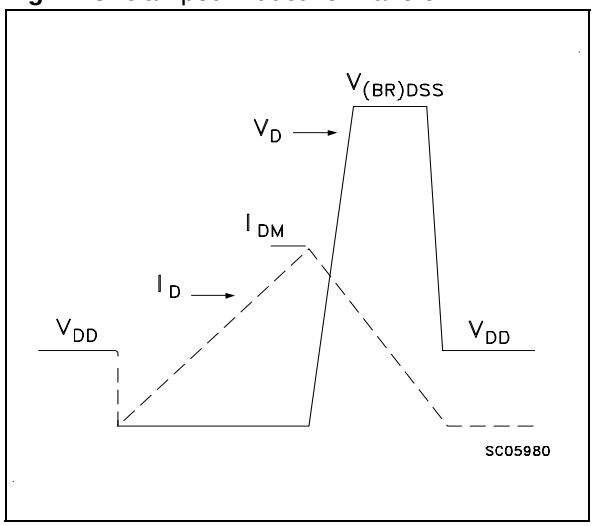



**Fig. 3:** Switching Times Test Circuits For Resistive Load

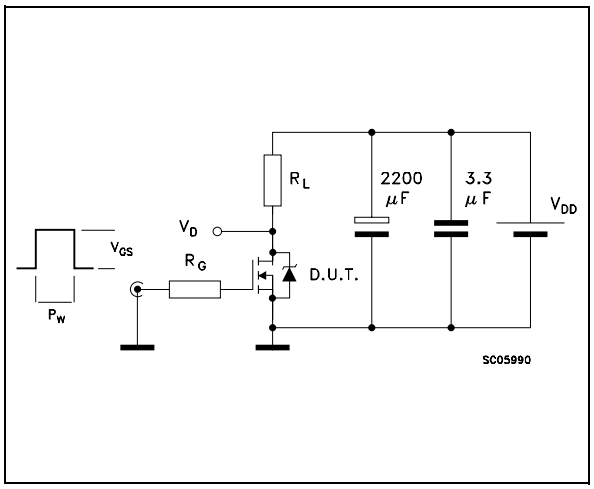



**Fig. 4:** Gate Charge test Circuit

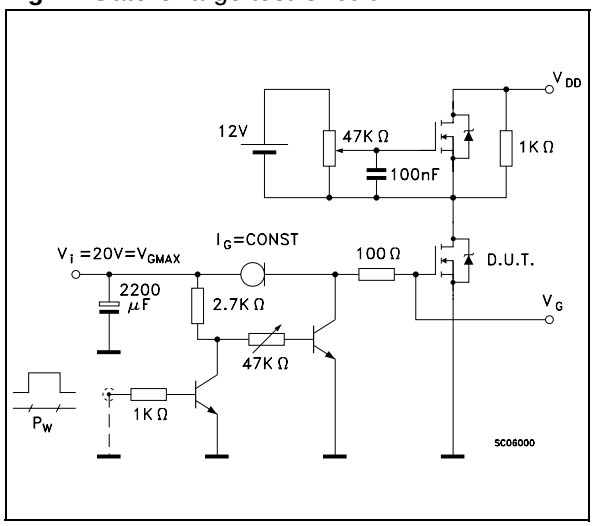
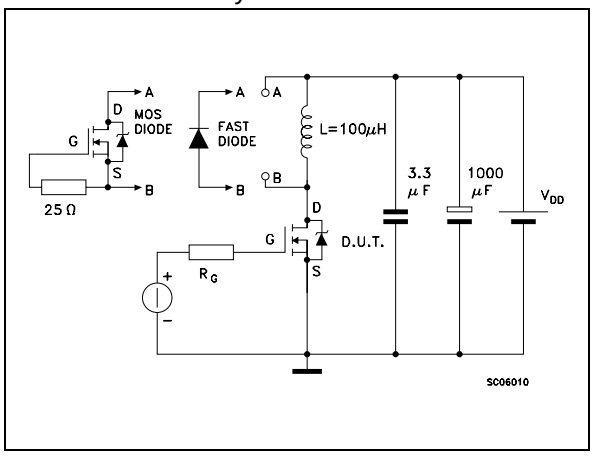
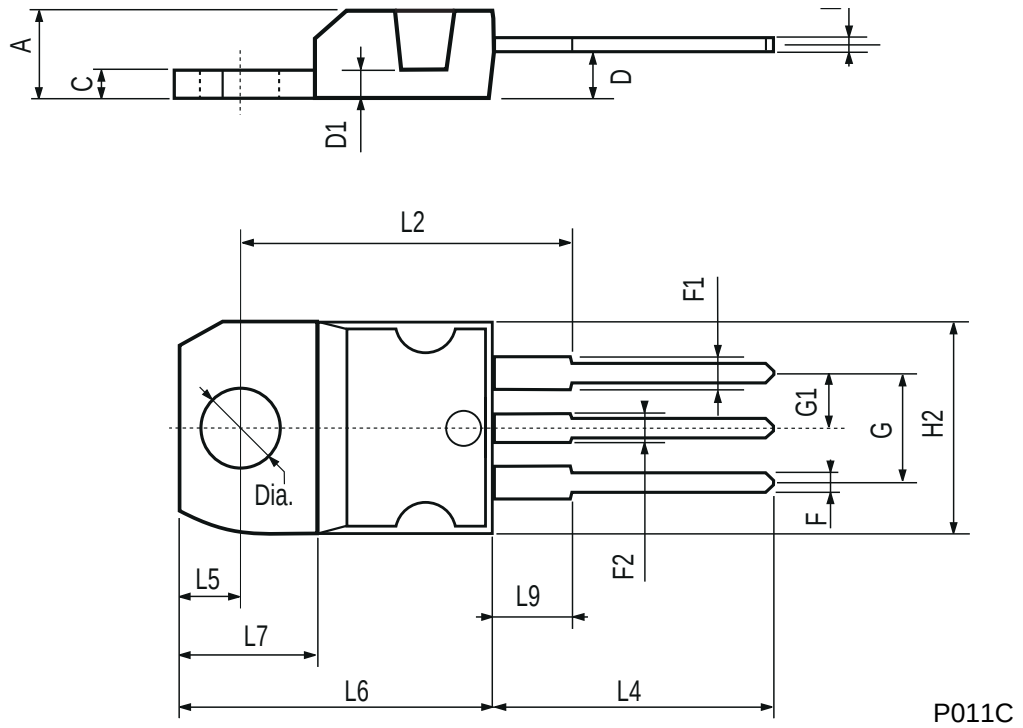



**Fig. 5:** Test Circuit For Inductive Load Switching And Diode Recovery Times



## TO-220 MECHANICAL DATA

| DIM. | mm | | | inch | | |
|---|---|---|---|---|---|---|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 4.40 | | 4.60 | 0.173 | | 0.181 |
| C | 1.23 | | 1.32 | 0.048 | | 0.051 |
| D | 2.40 | | 2.72 | 0.094 | | 0.107 |
| D1 | | 1.27 | | | 0.050 | |
| E | 0.49 | | 0.70 | 0.019 | | 0.027 |
| F | 0.61 | | 0.88 | 0.024 | | 0.034 |
| F1 | 1.14 | | 1.70 | 0.044 | | 0.067 |
| F2 | 1.14 | | 1.70 | 0.044 | | 0.067 |
| G | 4.95 | | 5.15 | 0.194 | | 0.203 |
| G1 | 2.4 | | 2.7 | 0.094 | | 0.106 |
| H2 | 10.0 | | 10.40 | 0.393 | | 0.409 |
| L2 | | 16.4 | | | 0.645 | |
| L4 | 13.0 | | 14.0 | 0.511 | | 0.551 |
| L5 | 2.65 | | 2.95 | 0.104 | | 0.116 |
| L6 | 15.25 | | 15.75 | 0.600 | | 0.620 |
| L7 | 6.2 | | 6.6 | 0.244 | | 0.260 |
| L9 | 3.5 | | 3.93 | 0.137 | | 0.154 |
| DIA. | 3.75 | | 3.85 | 0.147 | | 0.151 |

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